



Click [here](#) for the 3D model.

Dimensions

Chip Size	1206
L	3.07mm +/-0.38mm (0.121 in +/-0.015 in)
W	1.52mm +/-0.38mm (0.06 in +/-0.015 in)
T	1.6mm MAX (0.063 in MAX)
B	0.51mm +/-0.25mm (0.02 in +/-0.01 in)

Packaging Specifications

Packaging	T&R, Plastic Tape
-----------	-------------------

General Information

Series	GR900 SMD Space
Style	SMD Chip
RoHS	Yes
Termination	Tin
Failure Rate	N/A
Testing and Reliability	GR900 CSAM A
AEC-Q200	No
Shelf Life	78 Weeks
MSL	1

Specifications

Capacitance	0.047 uF
Capacitance Tolerance	10%
Voltage DC	50 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	BX